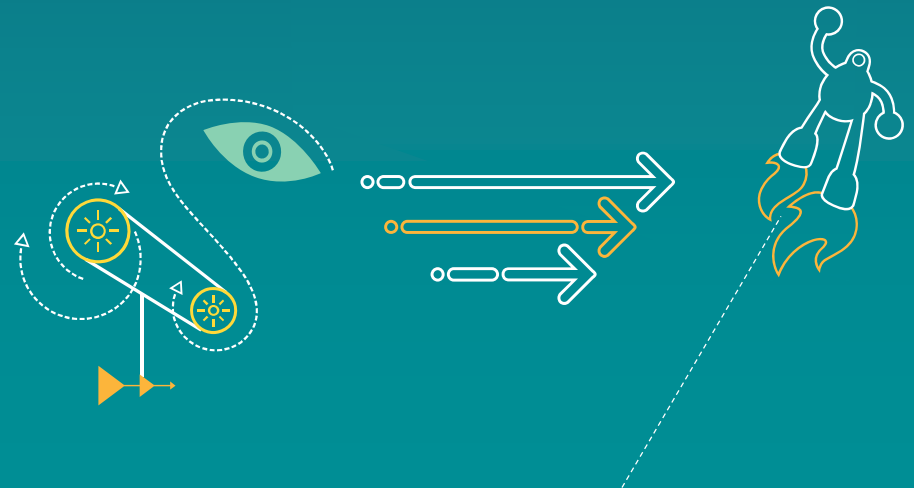

MTP9900 LAA FCC Internal PHOTOS



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80-P7567-6 Rev. A



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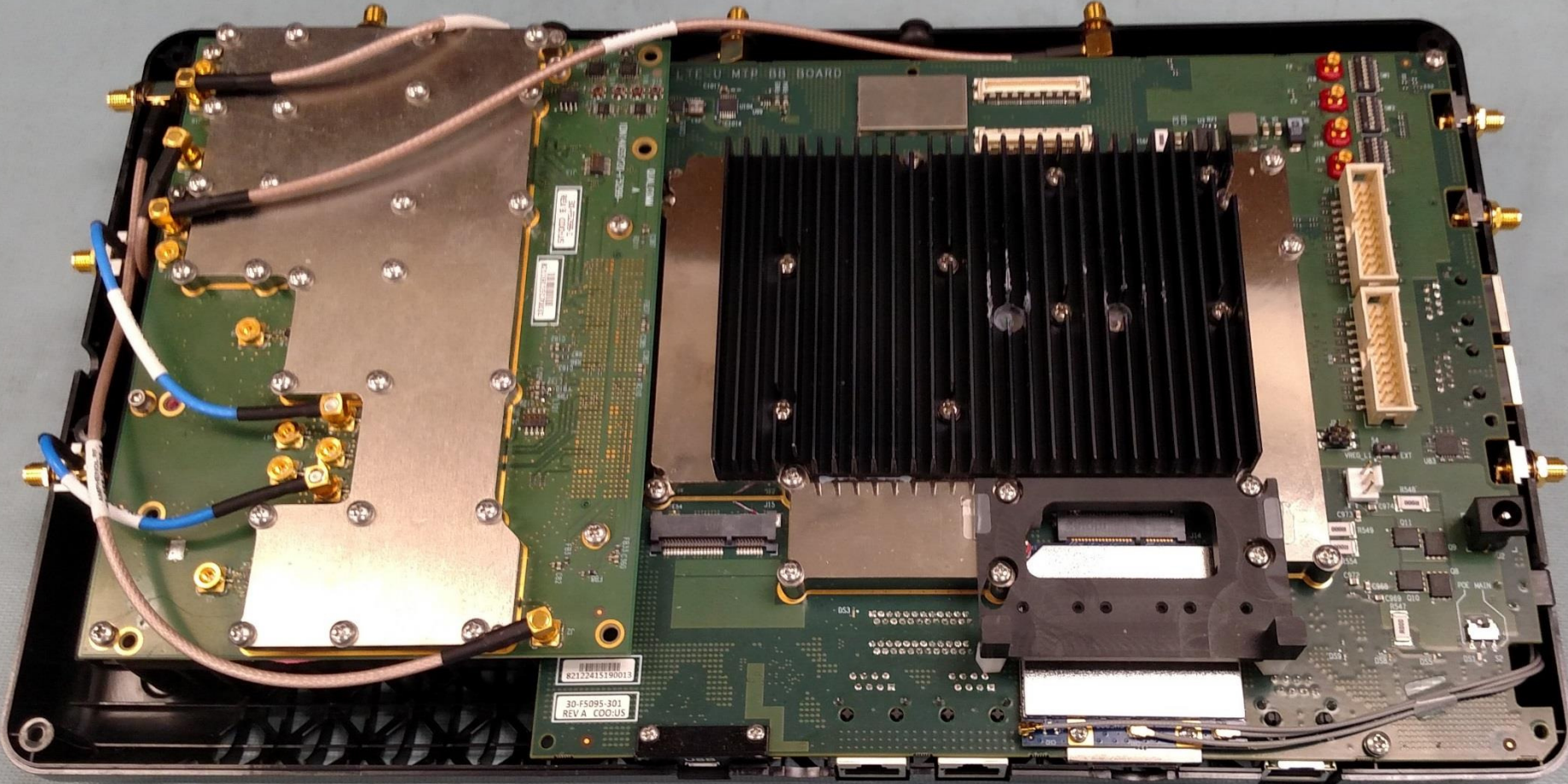
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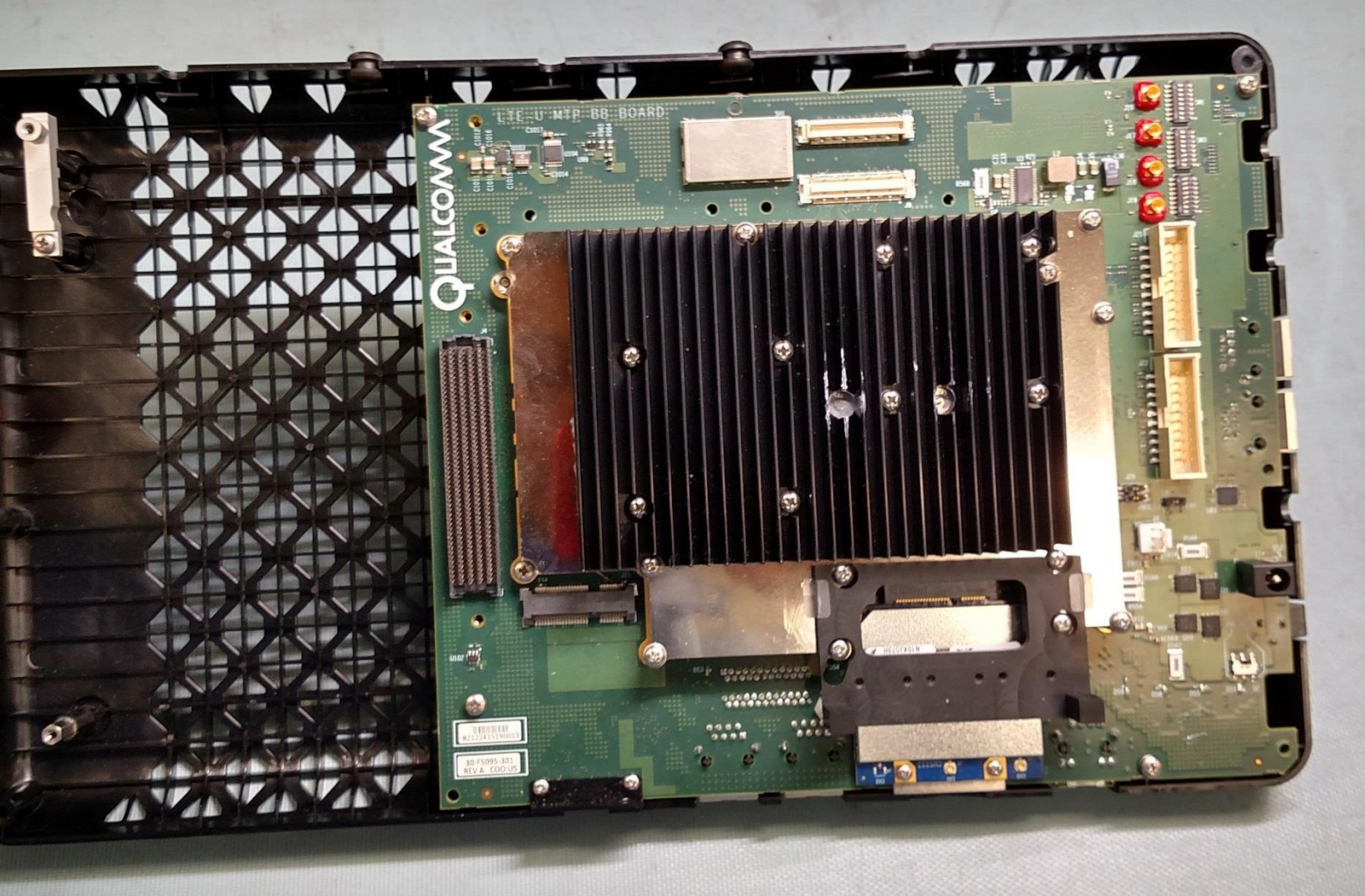
Revision History

Revision	Date	Description
A	July 2016	Initial release

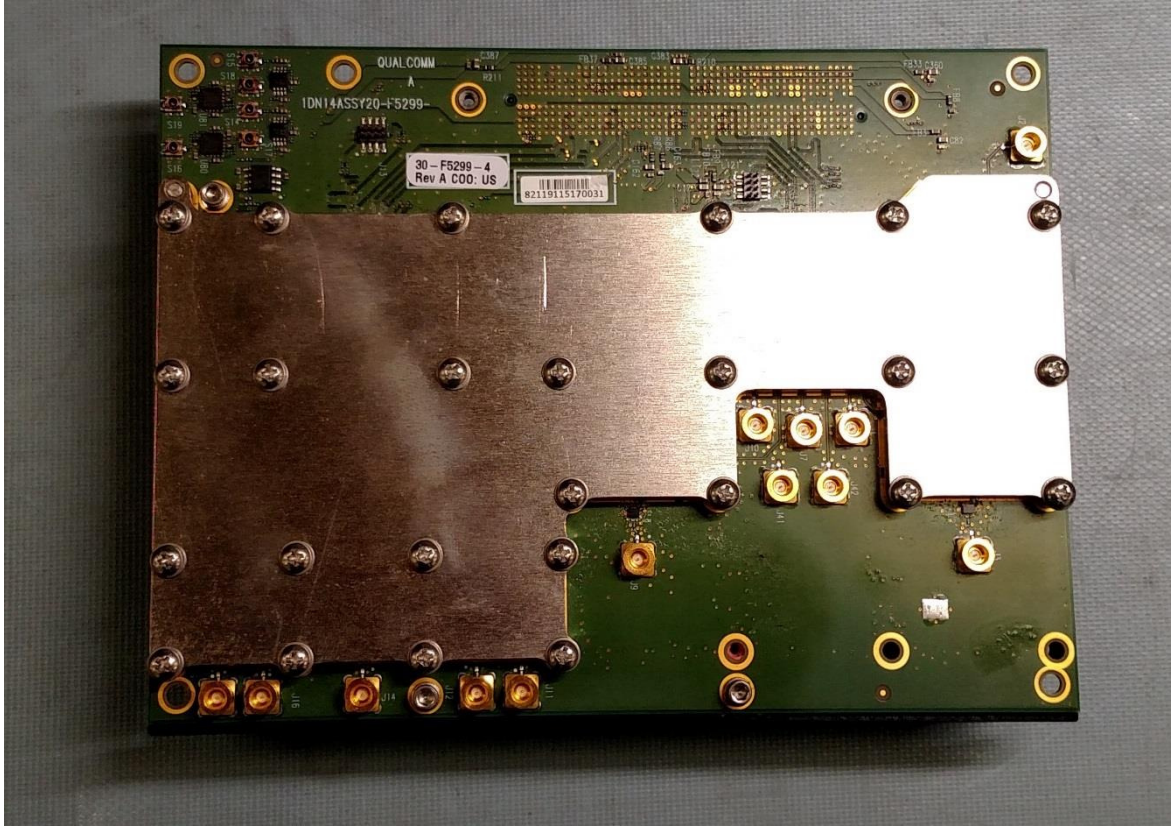
MTP9900 – Top Internal View



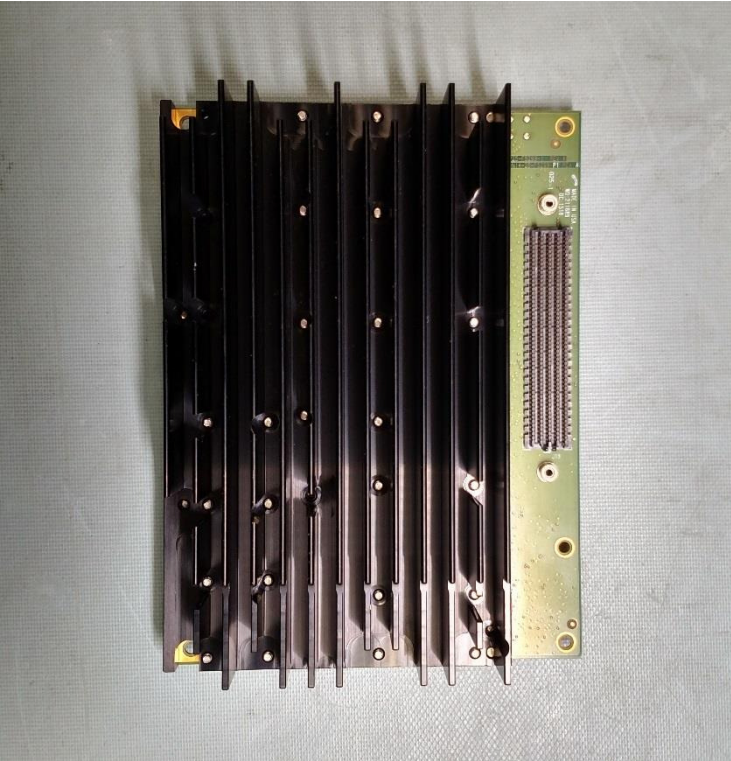
MTP9900 – Bottom Internal View



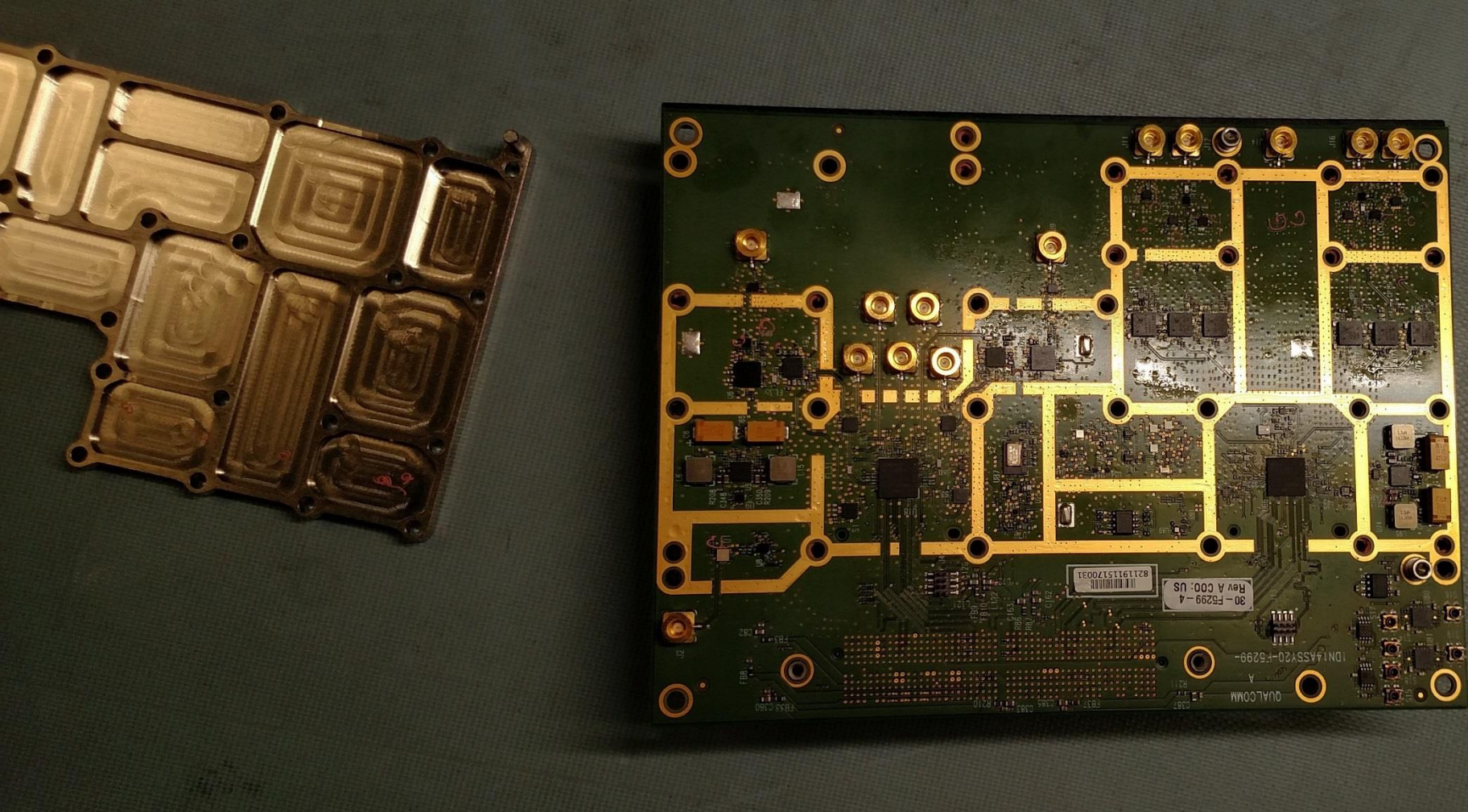
RF Card with Shield and Heatsink (1 of 2)



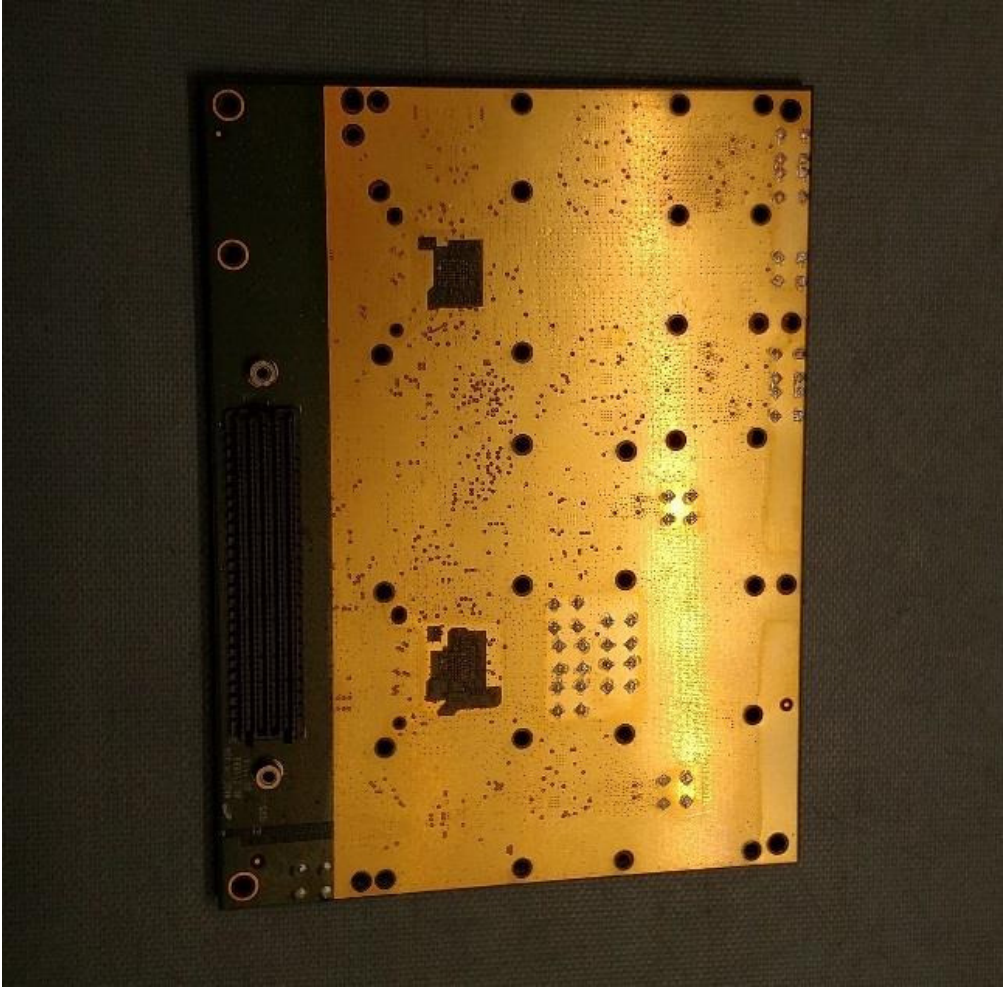
RF Card with Shield and Heatsink (2 of 2)



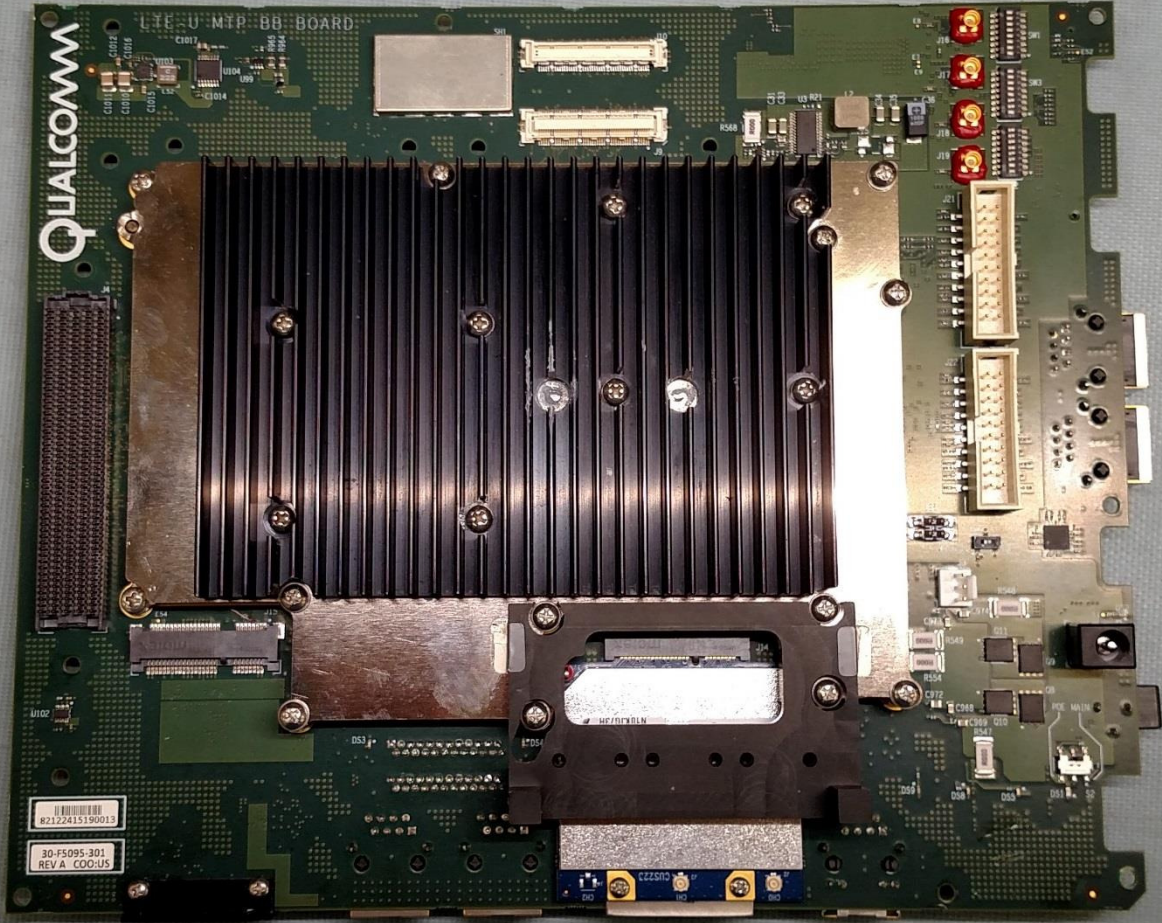
RF Board (1 of 2)



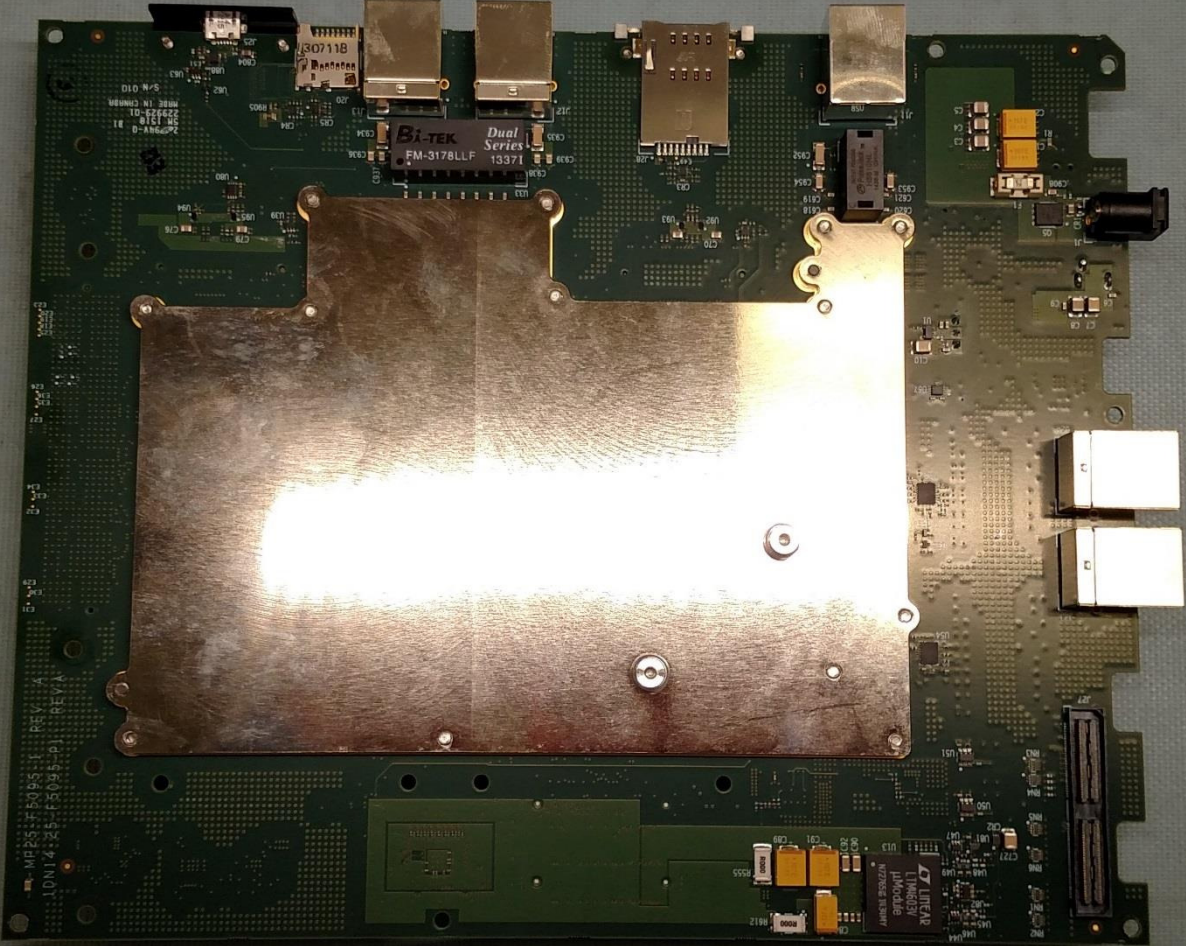
RF Board (2 of 2)



Baseband Board with Shield and Heatsink (1 of 2)



Baseband Board with Shield and Heatsink (2 of 2)



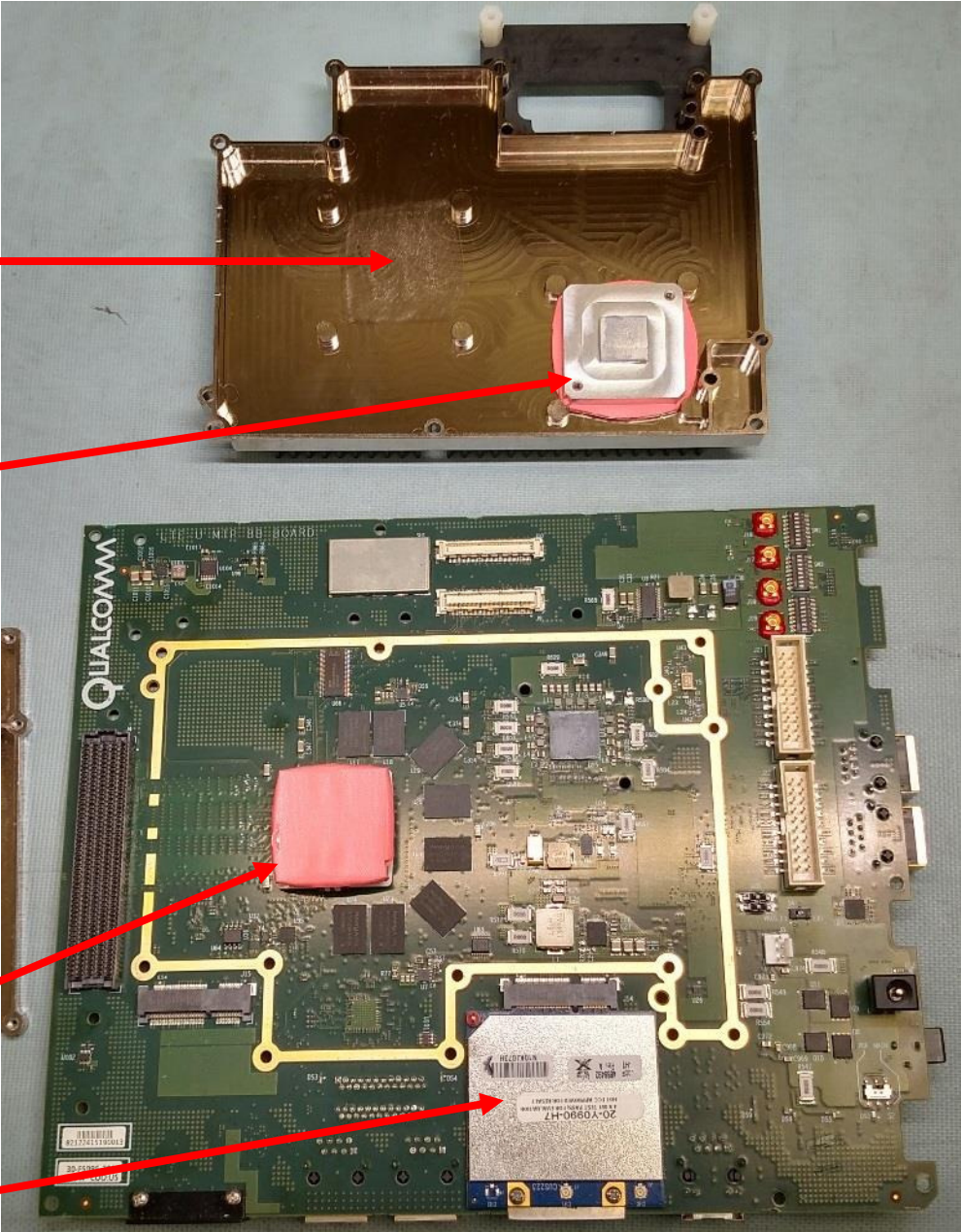
Baseband Board without Shield and Heatsink (1 of 2)

Top Shield

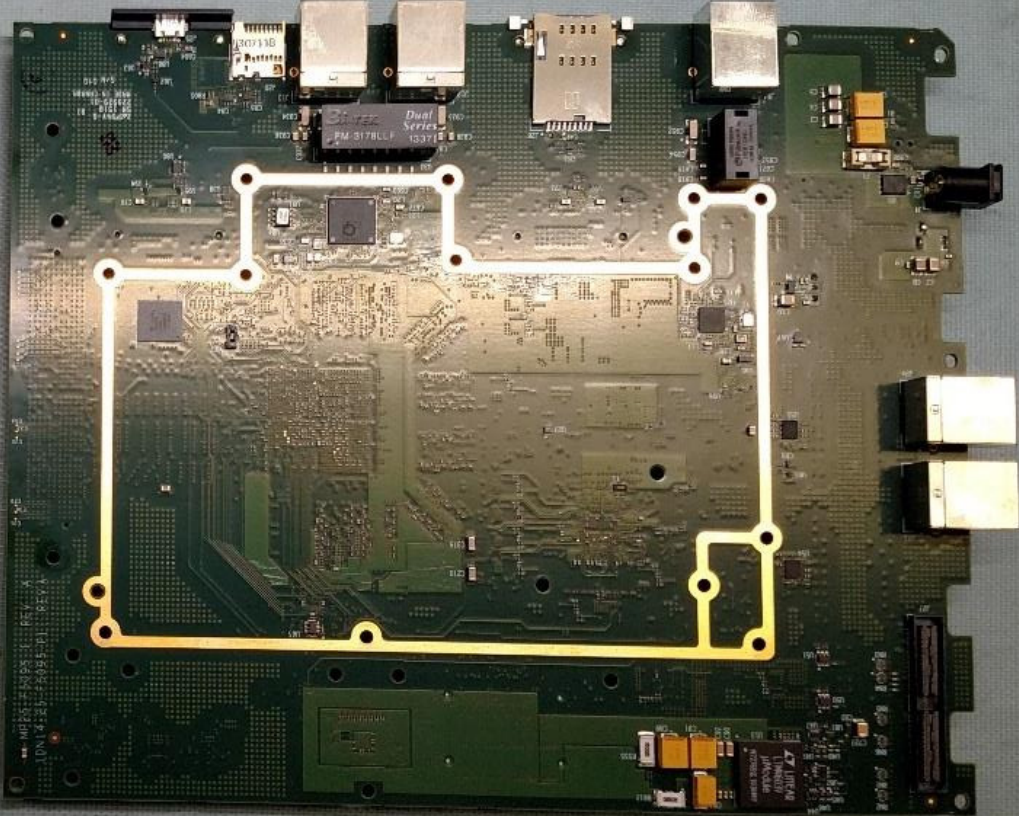
Heat Spreader and TIM

Heat Spreader and TIM

Wi-Fi Board

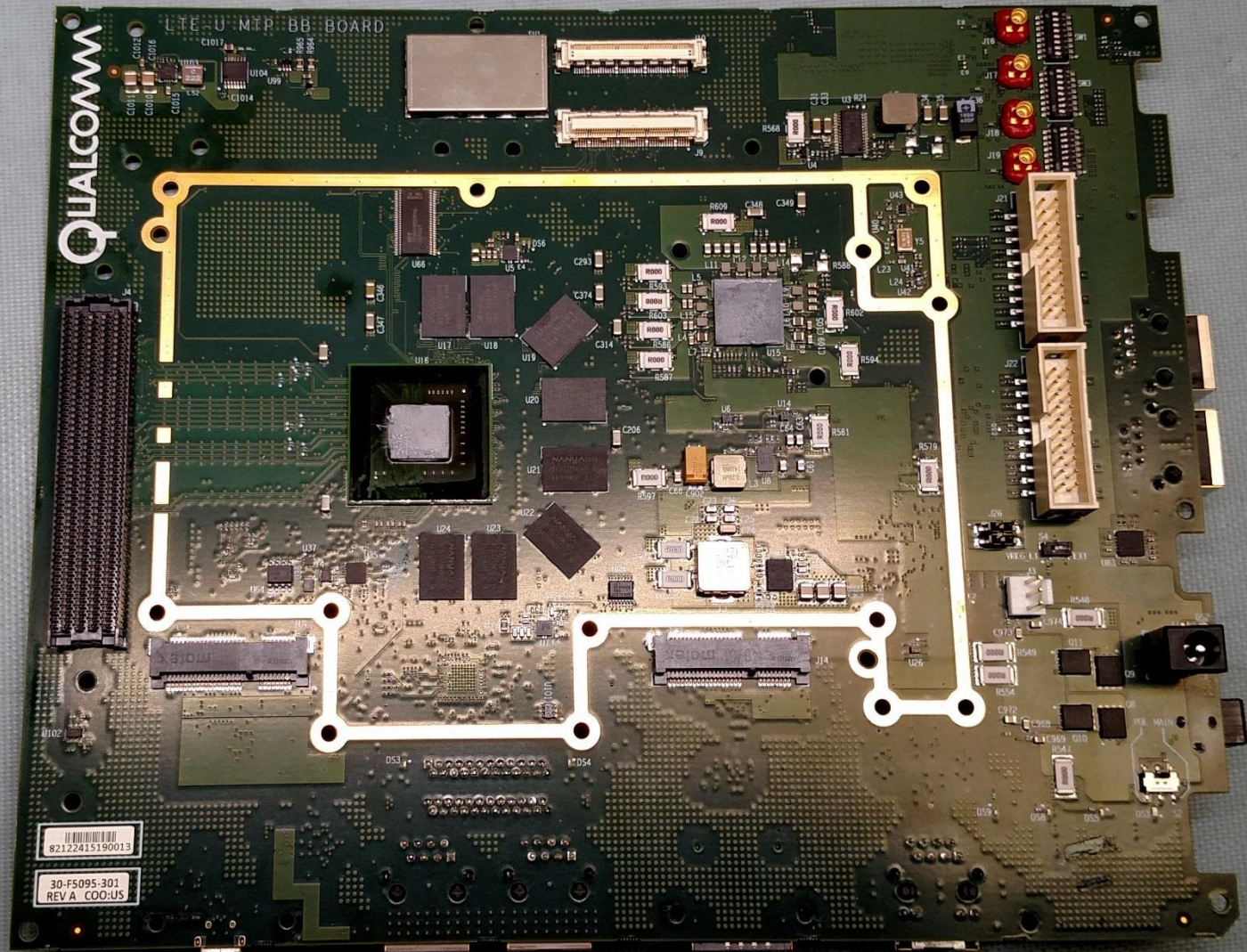


Baseband Board without Shield and Heatsink (2 of 2)



Bottom Shield

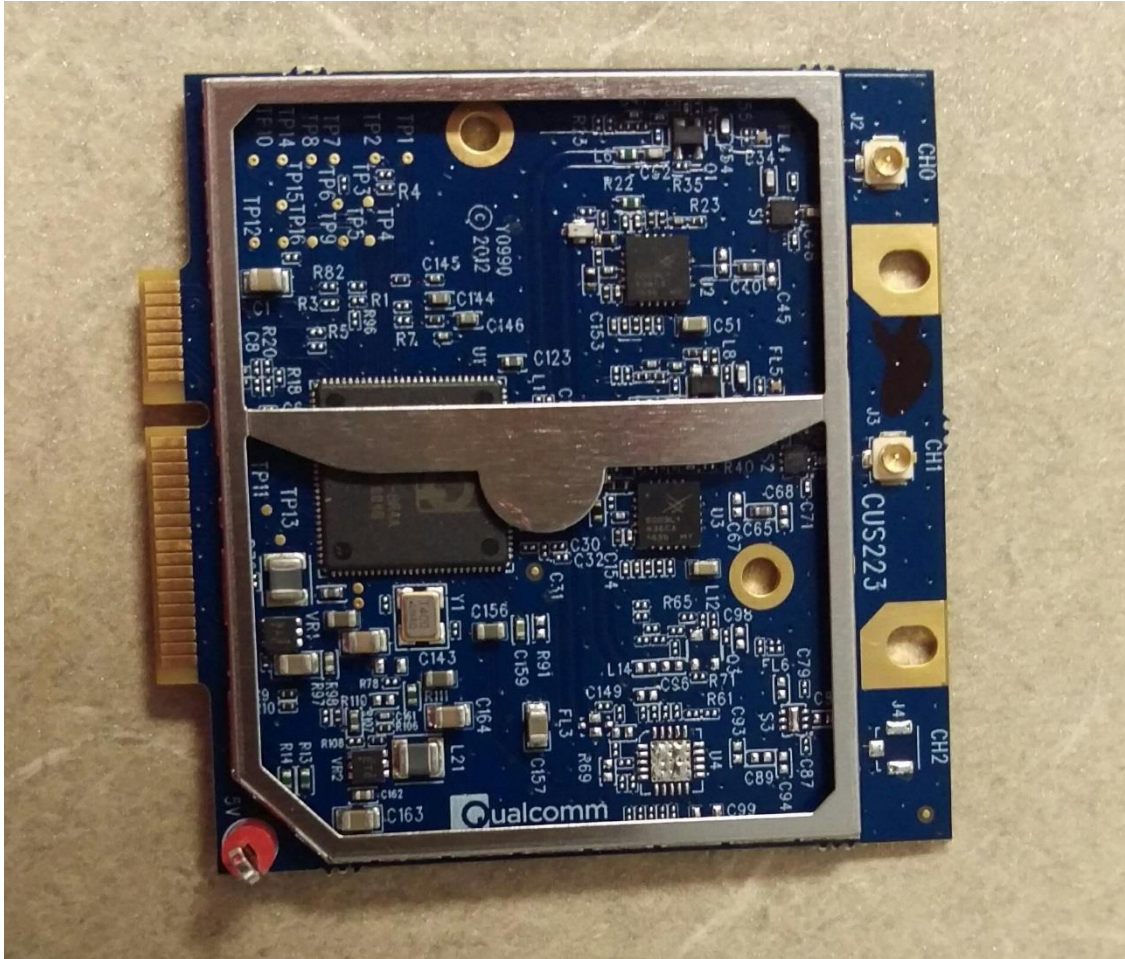
Baseband Board without Shield, Heatsink, Wi-Fi Board, or Heat Spreaders



Wi-Fi Board (1 of 2)



Wi-Fi Board – Internal



Thank You

